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40V P-Channel PowerTrench^o MOSFET

General Description

This PChannel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 20V).

Applications

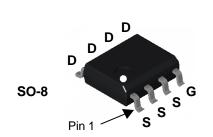
- Power management
- Load switch
- Battery protection

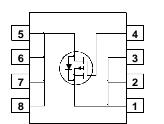
Features

• -11 A, -40 V
$$R_{DS(ON)} = 0.013 \ \Omega \ @V_{GS} = -10 \ V$$

 $R_{DS(ON)} = 0.017 \ \Omega \ @V_{GS} = -4.5 \ V$

- Fast switching speed
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-40	V
V _{GSS}	Gate-Source Voltage		±20	V
b	Drain Current – Continuous	(Note 1a)	-11	А
	– Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.4 (steady state)	W
		(Note 1b)	1.4	
		(Note 1c)	1.2	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	62.5 (steady state), 50 (10 sec)	°C/W
D	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
$R_{\theta JA}$			25	

Device MarkingDeviceReel SizeTape widthQuantityFDS4675FDS467513"12mm2500 units

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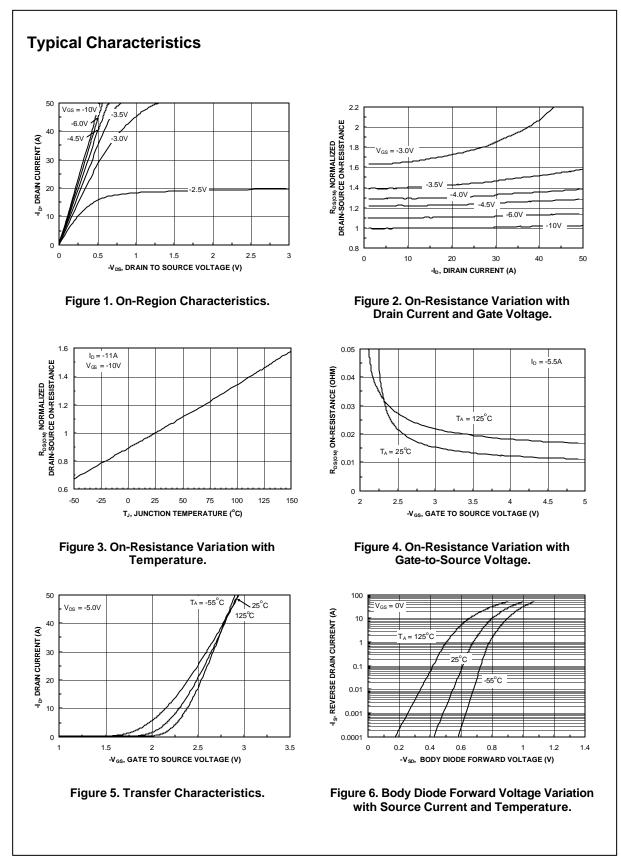
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics			1		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-40			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C		-34		mV/⁰C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -32 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.4	-3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4.6		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = -10 \text{ V}, \qquad I_D = -11 \text{ A}$		10	13	mΩ
	On–Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -9.5 \text{ A}$		13	17	
		V _{GS} =-10 V, I _D =-11 A, T _J =125°C		15	21	
D(on)	On–State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	-25			A
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -11 A$		44		S
Dynamio	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -20 V$, $V_{GS} = 0 V$,		4350		pF
Coss	Output Capacitance	f = 1.0 MHz		622		pF
Crss	Reverse Transfer Capacitance			290		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -20 V$, $I_D = -1 A$,		20	36	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		29	46	ns
t _{d(off)}	Turn–Off Delay Time			95	152	ns
t _f	Turn–Off Fall Time			60	96	ns
Qg	Total Gate Charge	$V_{DS} = -20 V$, $I_D = -11 A$,		40	56	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		11		nC
	Gate–Drain Charge			13		nC
Q _{gd}		and Maximum Ratings				
0	ource Diode Characteristics			1	0.4	•
Q _{gd} Drain–S Is	ource Diode Characteristics				-2.1	A

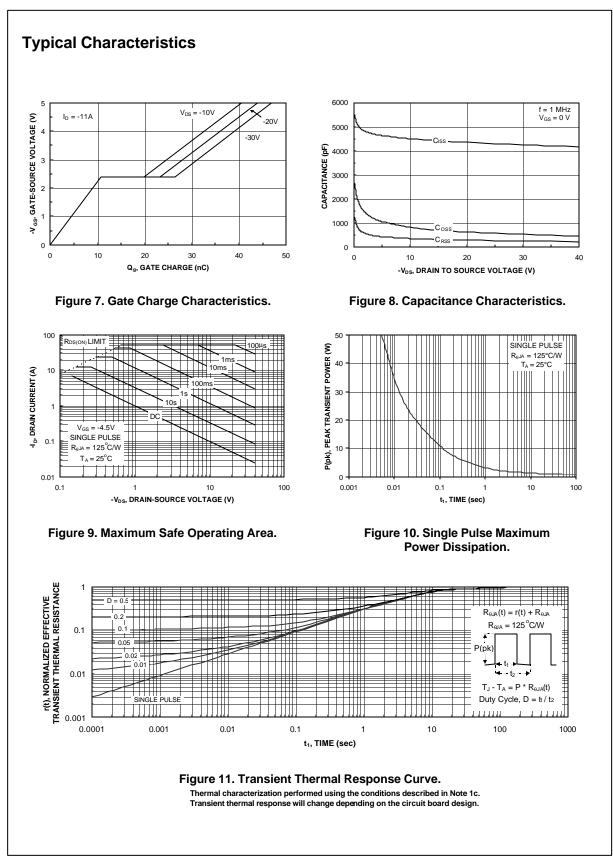
Scale 1 : 1 on letter size paper

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2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS4675 Rev C(W)





FDS4675 Rev C(W)

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